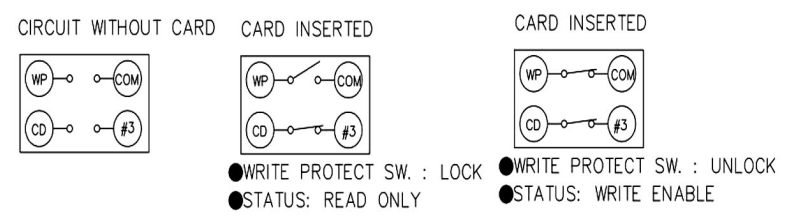
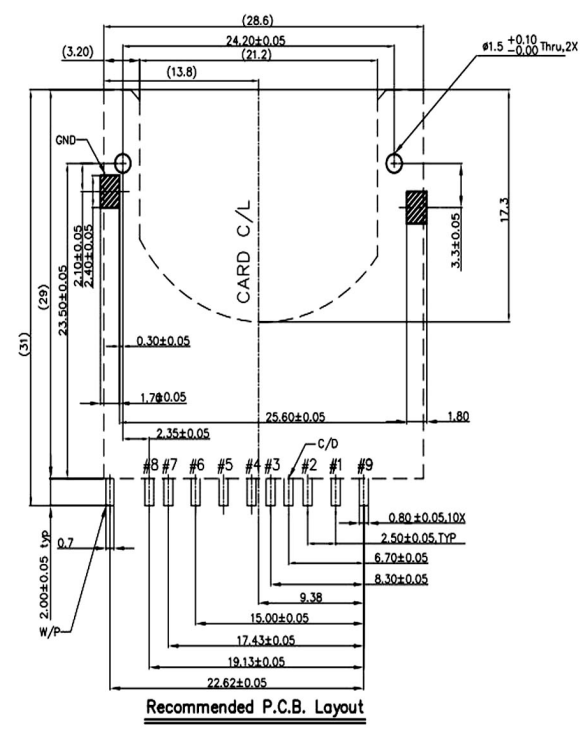
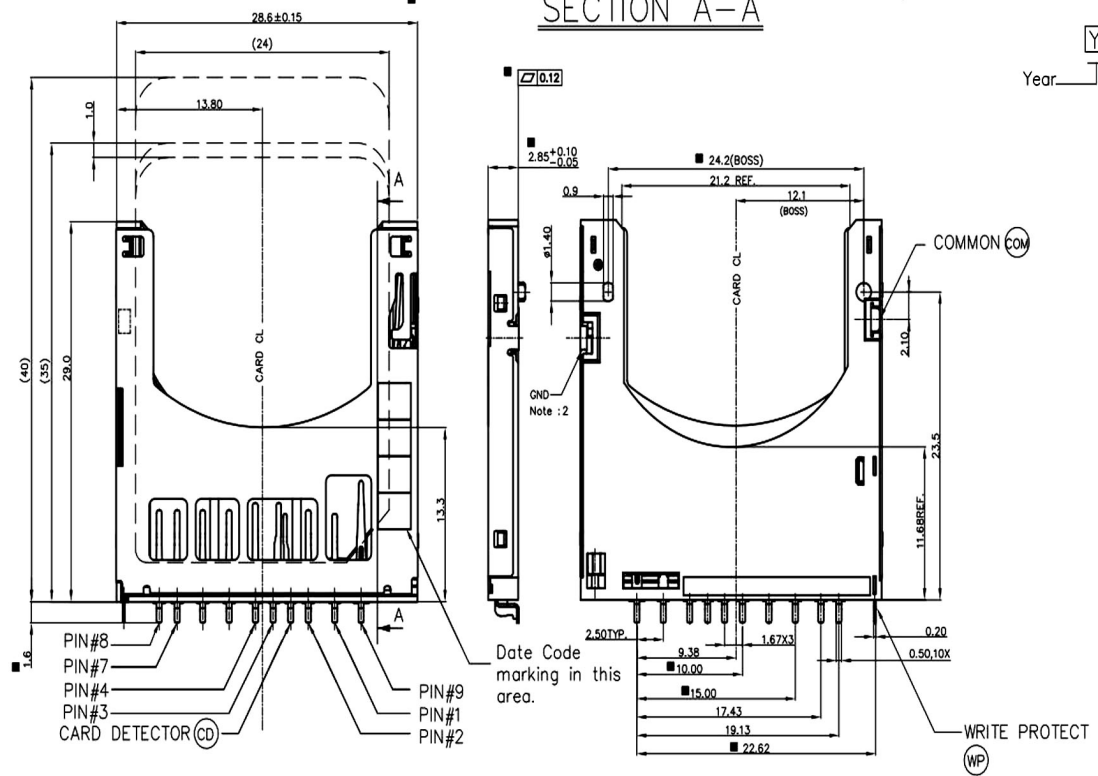


Material:
 Insulator: LCP+30% G.F., UL 94V-0 rated, Color Black.
 Contact: Phosphor Bronze
 Shield Cover: stainless steel sheet metal, SUS304, 0.2t.
 Contacts Plating:
 Contact Area: Gold Plating over 1.27um (50u") min Ni underplate.
 Soldering Zone: 3.5um (120u") min sn, over 1.27um (50u") min. Ni underplate.
 Gold plating in contact area: 3u" and 15u" Gold Plating.
 Shield Cover: Gold flash in soldering zone over Nickel under plating overall.

Date Code Marking:
 Year: Y W W X
 Weekday: W
 Week No.: X



RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准	SCALE 比例 参考	TOLERANCE ANG. ±5° 0. ±0.3 0.0 ±0.25 0.00 ±0.20	PART NAME 品名 SD MEMORY CARD CONNECTOR Push-Push SMT TYPE 9P REVERSE TYPE STAND OFF:0mm BLACK INSULATOR TRAY PACKING WITH SOLDER TAIL ROHS
DWG. 製圖 Betty	UNIT 單位 M M	SIZE. 紙張尺寸 A 4	PART NO. C0616-09RAXYB0R
DATE 制表日 2016/03/30	PAGE 張數 1 OF 1	REV. 版次 A	料號